

**PRODUCT RELIABILITY REPORT
FOR**

DS26556

Dallas Semiconductor

**4401 South Beltwood Parkway
Dallas, TX 75244-3292**

Prepared by:

**Don Lipps
Staff Reliability Engineer
Dallas Semiconductor
4401 South Beltwood Pkwy.
Dallas, TX 75244-3292
Email : don.lipps@dalsemi.com
ph: 972-371-3739
fax: 972-371-6016**

Conclusion:

The following qualification successfully meets the quality and reliability standards required of all Dallas Semiconductor products:

DS26556

In addition, Dallas Semiconductor's continuous reliability monitor program ensures that all outgoing product will continue to meet Maxim's quality and reliability standards. The current status of the reliability monitor program can be viewed at <http://www.maxim-ic.com/TechSupport/dsreliability.html>.

Device Description:

A description of this device can be found in the product data sheet. You can find the product data sheet at http://dbserv.maxim-ic.com/l_datasheet3.cfm.

Reliability Derating:

The Arrhenius model will be used to determine the acceleration factor for failure mechanisms that are temperature accelerated.

$$AfT = \exp((Ea/k) * (1/Tu - 1/Ts)) = tu/ts$$

AfT = Acceleration factor due to Temperature
tu = Time at use temperature (e.g. 55°C)
ts = Time at stress temperature (e.g. 125°C)
k = Boltzmann's Constant (8.617 x 10⁻⁵ eV/°K)
Tu = Temperature at Use (°K)
Ts = Temperature at Stress (°K)
Ea = Activation Energy (e.g. 0.7 ev)

The activation energy of the failure mechanism is derived from either internal studies or industry accepted standards, or activation energy of 0.7ev will be used whenever actual failure mechanisms or their activation energies are unknown. All deratings will be done from the stress ambient temperature to the use ambient temperature.

An exponential model will be used to determine the acceleration factor for failure mechanisms, which are voltage accelerated.

$$AfV = \exp(B * (Vs - Vu))$$

AfV = Acceleration factor due to Voltage
Vs = Stress Voltage (e.g. 7.0 volts)
Vu = Maximum Operating Voltage (e.g. 5.5 volts)
B = Constant related to failure mechanism type (e.g. 1.0, 2.4, 2.7, etc.)

The Constant, B, related to the failure mechanism is derived from either internal studies or industry accepted standards, or a B of 1.0 will be used whenever actual failure mechanisms or their B are unknown. All deratings will be done from the stress voltage to the maximum operating voltage. Failure rate data from the operating life test is reported using a Chi-Squared statistical model at the 60% or 90% confidence level (Cf).

The failure rate, Fr, is related to the acceleration during life test by:

$$Fr = X / (ts * AfV * AfT * N * 2)$$

X = Chi-Sq statistical upper limit
N = Life test sample size

Failure Rates are reported in FITs (Failures in Time) or MTTF (Mean Time To Failure). The FIT rate is related to MTTF by:

$$MTTF = 1/Fr$$

NOTE: MTTF is frequently used interchangeably with MTBF.

The calculated failure rate for this device/process is:

FAILURE RATE: **MTTF (YRS): 79860** **FITS: 1.4**

The parameters used to calculate this failure rate are as follows:

Cf: 60% **Ea: 0.7** **B: 0** **Tu: 25 °C** **Vu: 3.5 Volts**

The reliability data follows. At the start of this data is the device information. The next section is the detailed reliability data for each stress. The reliability data section includes the latest data available and may contain some generic data. "*" after DATE CODE denotes specific product data.

Device Information:

Process: 2P, 4M,0.35um,Sil.P1,P2Cap,Ti/TiN M1-M4,BPSG,Masked
 Passivation: Passivation w/Nov TEOS Oxide-Nitride
 Die Size: 403 x 481
 Number of Transistors: 3700000
 Interconnect: Aluminum / 1% Silicon / 0.5% Copper
 Gate Oxide Thickness: 75 Å

ELECTRICAL CHARACTERIZATION

DESCRIPTION	DATE CODE	CONDITION	READPOINT	QTY	FAILS	FA#
ESD SENSITIVITY	0440 *	EOS/ESD S5.1 HBM 500 VOLTS	1 PUL'S	3	0	
ESD SENSITIVITY	0440 *	EOS/ESD S5.1 HBM 1000 VOLTS	1 PUL'S	3	0	
ESD SENSITIVITY	0440 *	EOS/ESD S5.1 HBM 2000 VOLTS	1 PUL'S	3	0	
ESD SENSITIVITY	0440 *	EOS/ESD S5.1 HBM 4000 VOLTS	1 PUL'S	3	3	No FA
ESD SENSITIVITY	0440 *	EOS/ESD S5.1 HBM 8000 VOLTS	1 PUL'S	3	3	No FA
LATCH-UP	0440 *	JESD78, I-TEST 125C	2 DYS	6	0	
LATCH-UP	0440 *	JESD78, Vsupply TEST 125C	2 DYS	6	0	
Total:					6	

OPERATING LIFE

DESCRIPTION	DATE CODE	CONDITION	READPOINT	QTY	FAILS	FA#
HIGH VOLTAGE LIFE	0150	125C, 3.5 VOLTS	1000 HRS	77	0	
HIGH VOLTAGE LIFE	0213	125C, 3.5 VOLTS	1000 HRS	71	0	
HIGH VOLTAGE LIFE	0222	125C, 3.5 VOLTS	1000 HRS	45	0	
HIGH VOLTAGE LIFE	0233	125C, 3.5 VOLTS	1000 HRS	77	0	
HIGH VOLTAGE LIFE	0234	125C, 3.5 VOLTS	1000 HRS	45	0	
HIGH TEMP OP LIFE	0317	125C, 3.5 VOLTS	1000 HRS	45	0	
HIGH VOLTAGE LIFE	0332	125C, 3.5 VOLTS	1000 HRS	42	0	

HIGH TEMP OP LIFE	0403	125C, 3.5 VOLTS	1000 HRS	45	0
HIGH TEMP OP LIFE	0417	125C, 3.5 VOLTS	1000 HRS	45	0
HIGH TEMP OP LIFE	0418	125C, 3.5 VOLTS	1000 HRS	45	0
HIGH TEMP OP LIFE	0425	125C, 3.5 VOLTS	1000 HRS	44	0
HIGH TEMP OP LIFE	0436	125C, 3.5 VOLTS	1000 HRS	45	0
HIGH TEMP OP LIFE	0440 *	125C, 3.5 VOLTS	192 HRS	45	0
HIGH TEMP OP LIFE	0442	125C, 3.5 VOLTS	1000 HRS	45	0
			Total:		0

FAILURE RATE: **MTTF (YRS): 79860**

FITS: 1.4